PRODUCT FEATURES

☐ IGBT3 CHIP(1700V Trench+Field Stop technology)

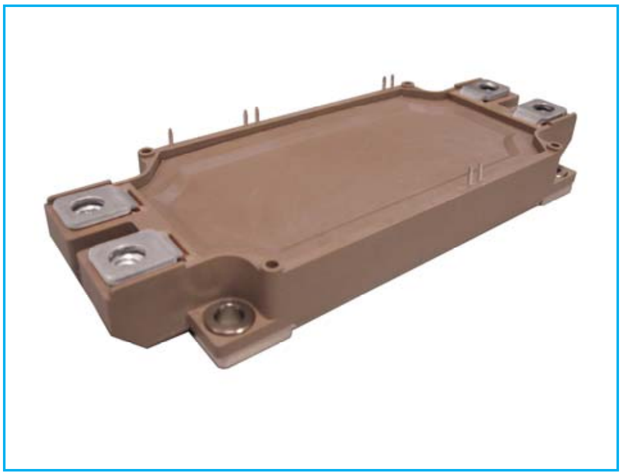
☐ Low turn-off losses, short tail current

☐ $V_{CE(sat)}$ with positive temperature coefficient

☐ DIODE CHIP(1700V EMCON 3 technology)

☐ Free wheeling diodes with fast and soft reverse recovery

☐ Temperature sense included



APPLICATIONS

☐ AC motor control

☐ Motion/servo control

☐ Inverter and power supplies

☐ Photovoltaic/Fuel cell

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS(T_C=25°C *unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	T_J=25℃	1700	V
V_{GES}	Gate Emitter Voltage		±20	
I_C	DC Collector Current	T_C=25℃, T_{Jmax}=175℃	900	A
		T_C=100℃, T_{Jmax}=175℃	600	
I_{CM}	Repetitive Peak Collector Current	tp=1ms	1200	
P_{tot}	Power Dissipation Per IGBT	T_C=25℃, T_{Jmax}=175℃	3750	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS (T_C=25°C *unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	T_J=25℃	1700	V
$I_{F(AV)}$	Average Forward Current		600	A
I_{FRM}	Repetitive Peak Forward Current	tp=1ms	1200	
I^2t		T_J=125℃, t=10ms, V_R=0V	35000	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions			Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	V_{CE}=V_{GE}, I_C=24mA		5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	I_C=600A, V_{GE}=15V, T_J=25℃			2	2.45	
		I_C=600A, V_{GE}=15V, T_J=125℃			2.4		
I_{CES}	Collector Leakage Current	V_{CE}=1700V, V_{GE}=0V, T_J=25℃				3	mA
		V_{CE}=1700V, V_{GE}=0V, T_J=125℃				20	mA
I_{GES}	Gate Leakage Current	V_{CE}=0V,V_{GE}=±15V, T_J=25℃		-400		400	nA
R_{gint}	Integrated Gate Resistor				1.3		Ω
Q_g	Gate Charge	V_{CE}=900V, I_C=600A , V_{GE}=±15V			6.8		μC
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f =1MHz			54		nF
C_{res}	Reverse Transfer Capacitance				1.8		nF
$t_{d(on)}$	Turn on Delay Time	V_{CC}=900V,I_C=600A R_G =2.5Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		320		ns
			T_J=125℃		350		ns
t_r	Rise Time		T_J=25℃		100		ns
			T_J=125℃		120		ns
$t_{d(off)}$	Turn off Delay Time	V_{CC}=900V,I_C=600A R_G =2.5Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		900		ns
			T_J=125℃		1100		ns
t_f	Fall Time		T_J=25℃		200		ns
			T_J=125℃		350		ns
E_{on}	Turn on Energy	V_{CC}=900V,I_C=600A R_G =2.5Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		120		mJ
			T_J=125℃		170		mJ
E_{off}	Turn off Energy		T_J=25℃		128		mJ
			T_J=125℃		187		mJ
I_{SC}	Short Circuit Current	tpsc≤10μS , V_{GE}=15V T_J=125℃,V_{CC}=1000V			2400		A
R_{thJC}	Junction to Case Thermal Resistance （Per IGBT）					0.04	K /W

Diode-inverter

ELECTRICAL CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	I_F=600A , V_{GE}=0V, T_J=25℃		1.8	2.2	V
		I_F=600A , V_{GE}=0V, T_J=125℃		1.9		
I_{RRM}	Max. Reverse Recovery Current	I_F=600A , V_R=900V dI_F/dt=-5000A/μs T_J =125℃		700		A
Q_{RR}	Reverse Recovery Charge			260		μC
E_{rec}	Reverse Recovery Energy			147		mJ
R_{thJCD}	Junction to Case Thermal Resistance （Per Diode）				0.09	K /W

NTC CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
R_{25}	Resistance	T_C =25℃		5		KΩ
$B_{25/50}$	$R_2 = R_{25}$ exp $[B_{25/50}(1/T_2$ - 1/(298.15 K))]			3375		K

MODULE CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		175	℃
T_{Jop}	Operating Temperature		-40~150	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	4000	V
CTI	Comparative Tracking Index		﹥225	
Torque	to heatsink	Recommended（M5）	2.5~5	Nm
	to terminal	Recommended（M6）	3~5	Nm
Weight			350	g

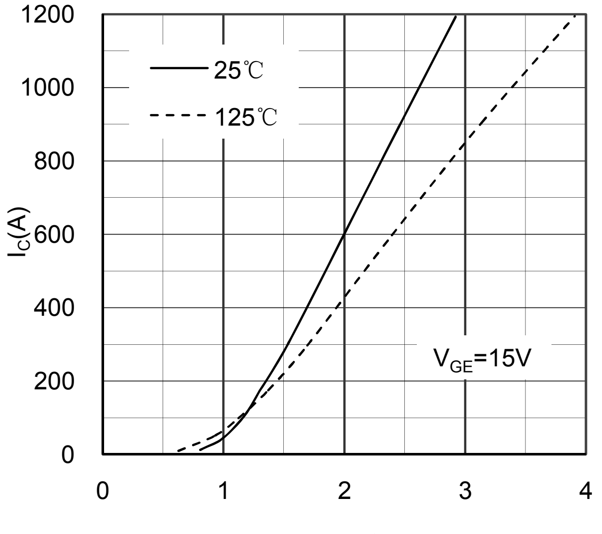


Figure 1. Typical Output Characteristics IGBT-inverter

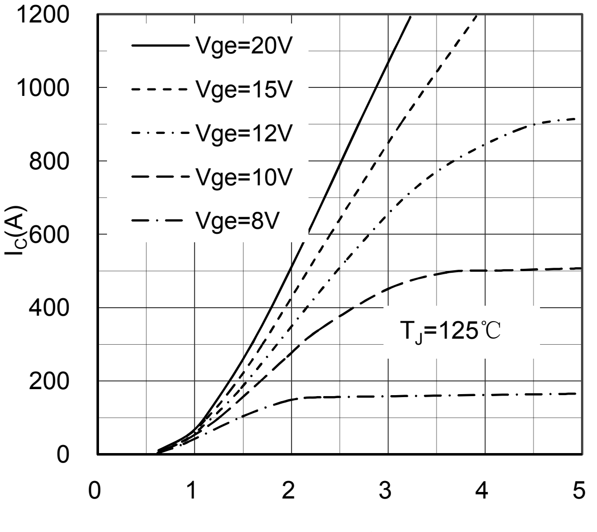


Figure 2. Typical Output Characteristics IGBT-inverter

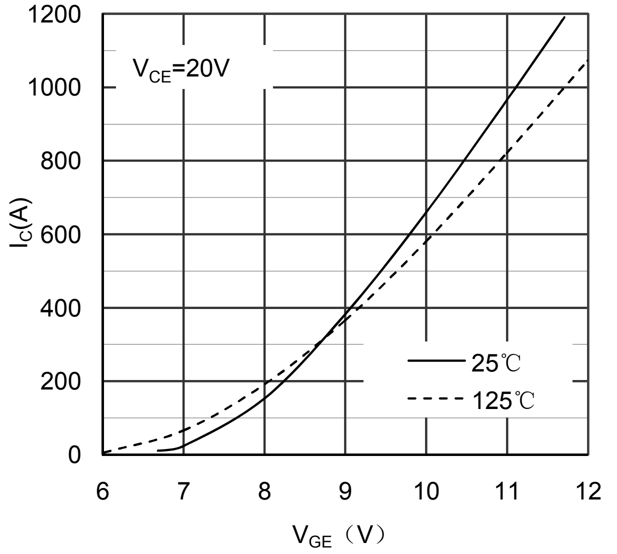


Figure 3. Typical Transfer characteristics IGBT-inverter

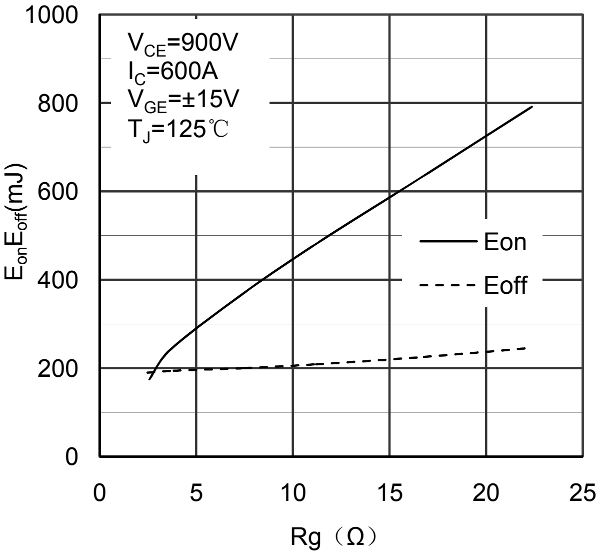


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

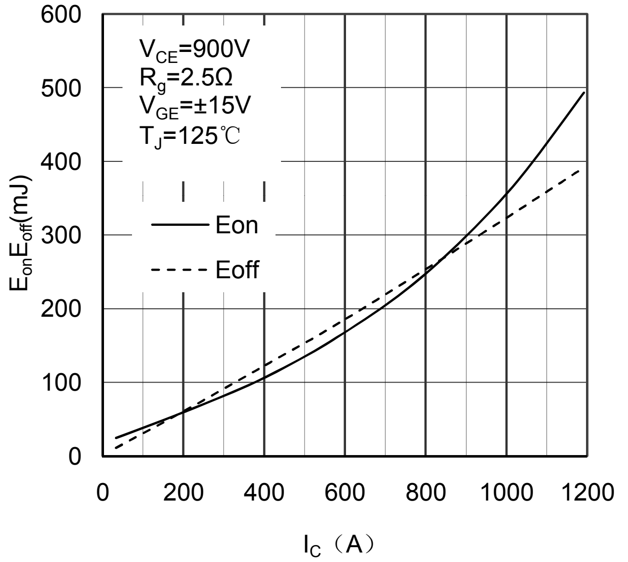


Figure 5. Switching Energy vs Collector Current IGBT-inverter

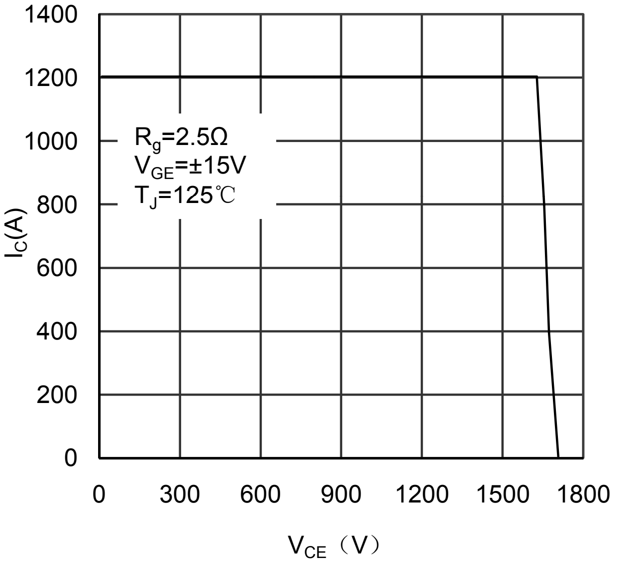


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

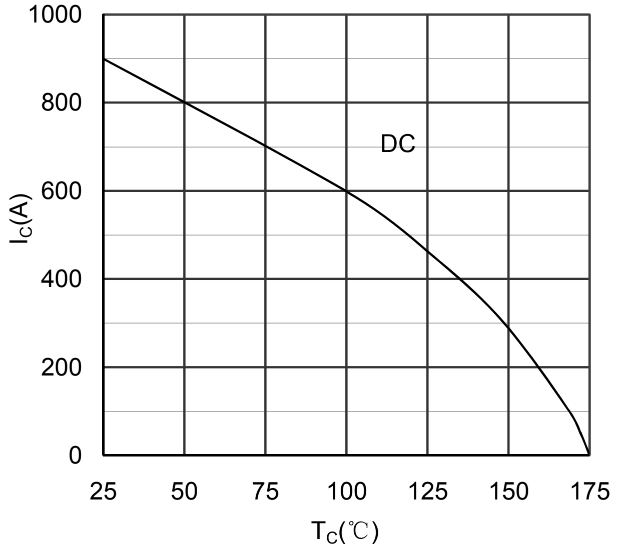


Figure 7. Collector Current vs Case temperature IGBT -inverter

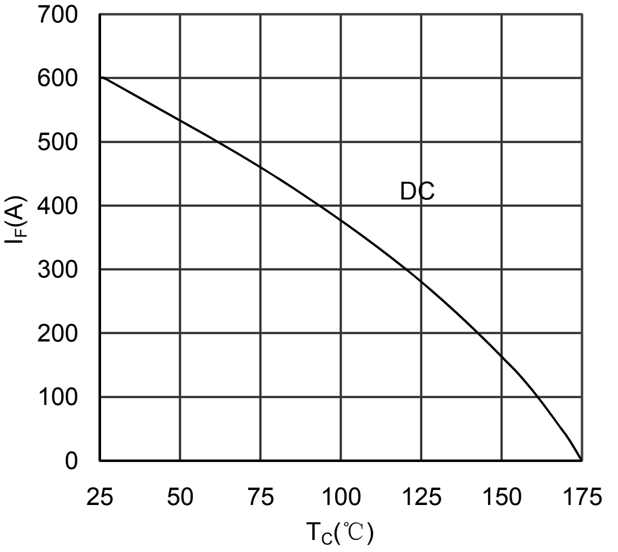


Figure 8. Forward current vs Case temperature Diode -inverter

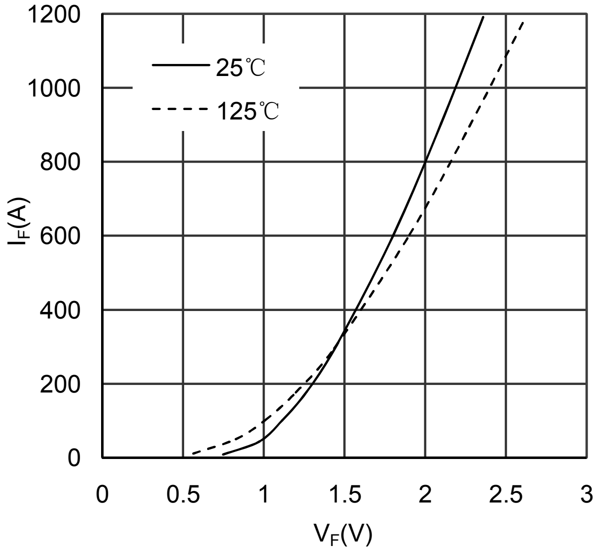


Figure 9. Diode Forward Characteristics Diode -inverter

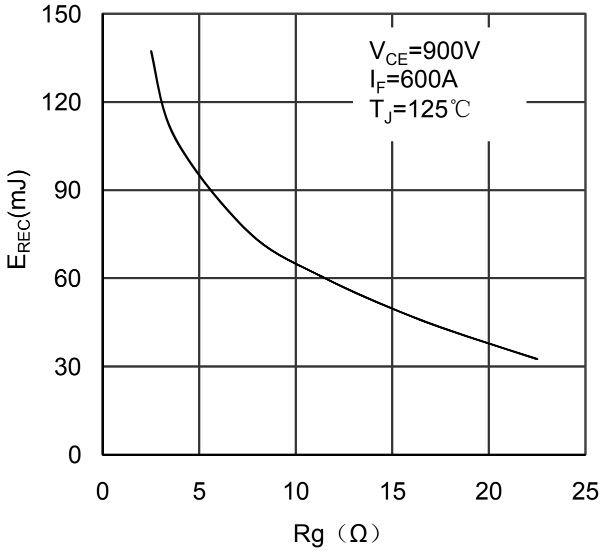


Figure 10. Switching Energy vs Gate Resistor Diode - inverter

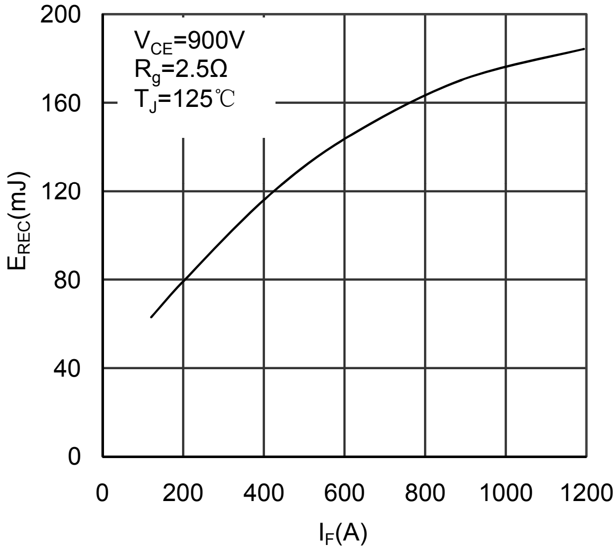


Figure 11. Switching Energy vs Forward Current Diode-inverter

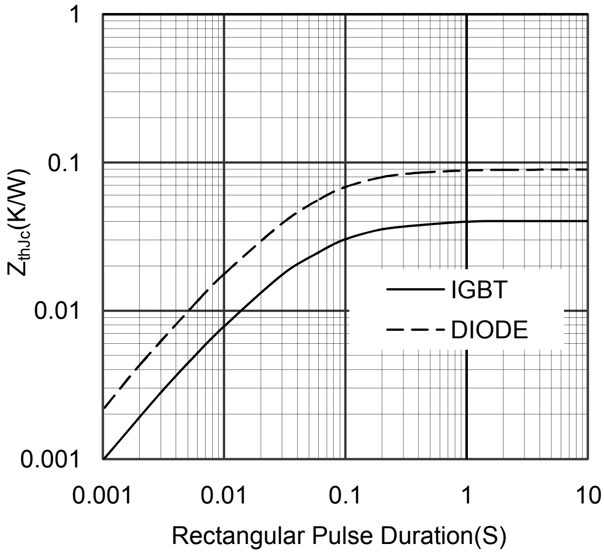


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

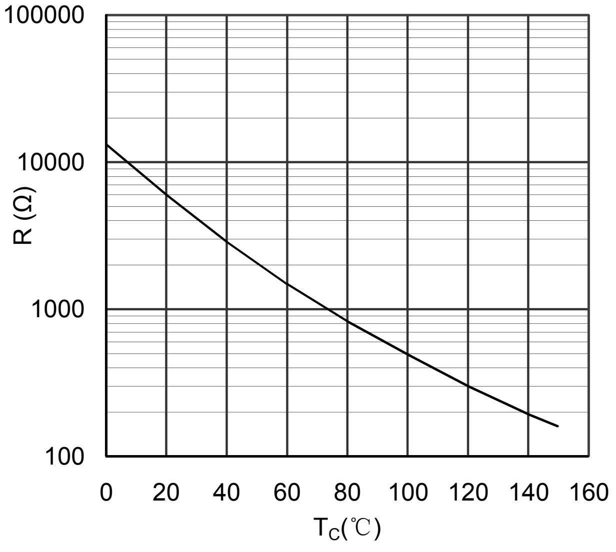


Figure 13. NTC Characteristics

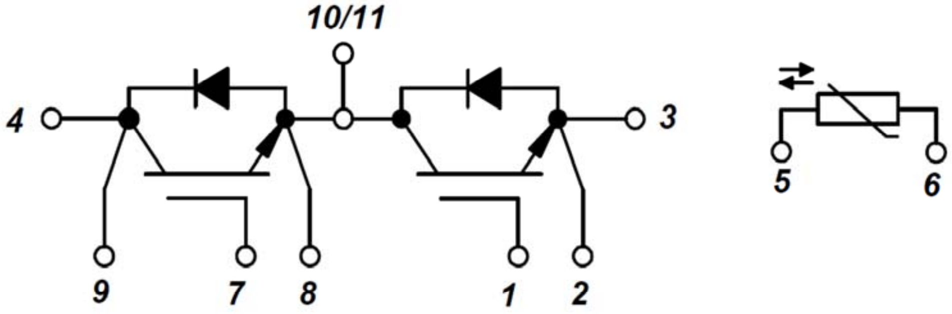
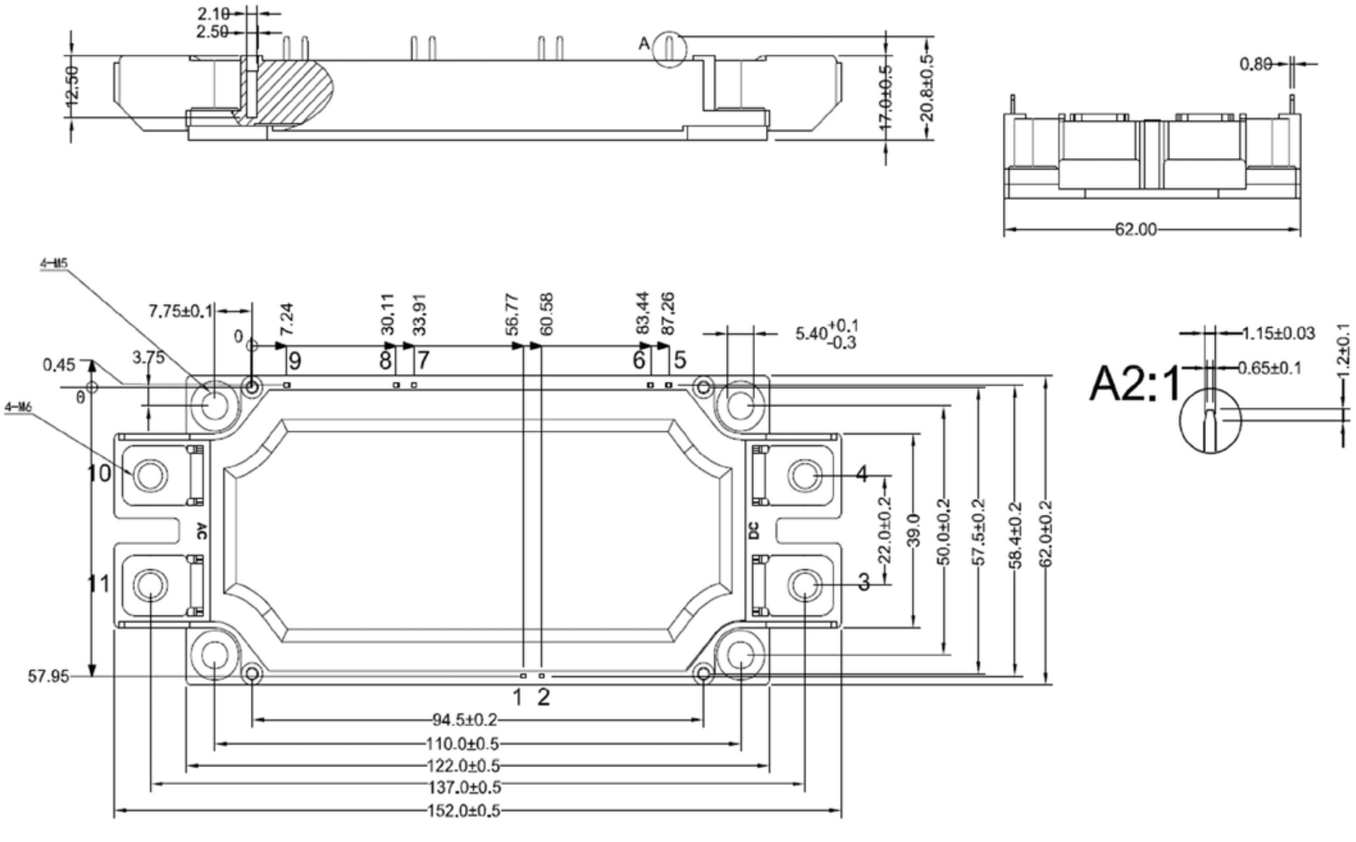


Figure 14. Circuit Diagram



Dimensions in (mm)

Figure 15. Package Outline